



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

**Notification# 20200625004
Datasheet for LM317
Information Only**

Date: July 21, 2020
To: TOKYO ELECTRON DEVICE (DSTR) PCN

Dear Customer:

This is an information-only announcement of a change to the datasheet for a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN team (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team
SC Business Services


**Information Only
Attachments**

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
LM317KTTR	null
LM317KCS	null
LM317DCYR	null
LM317KCSE3	null

Technical details of this Product Change follow on the next page(s).

Notification Number:	20200625004	Notification Date:	July 21, 2020
Title:	Datasheet for LM317		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input checked="" type="checkbox"/>	Data Sheet
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Materials
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process
Notification Details			
Description of Change:			
<p>Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.</p>			
 <div style="float: right;"> LM317 SLVS044Y – SEPTEMBER 1997 – REVISED APRIL 2020 </div>			
Changes from Revision X (September 2016) to Revision Y			Page
• Added <i>Device Comparison Table</i>			3
• Changed V_{IN} to I_{OUT} in <i>Load Transient Response</i> figures			7
• Added missing caption to second y-axis in second <i>Load Transient Response</i> figure			7
• Changed V_{OUT} and output impedance equations in <i>Battery-Charger Circuit</i> section			14
The datasheet number will be changing.			
Device Family	Change From:	Change To:	
LM317	SLVS044X	SLVS044Y	
These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/LM317			
Reason for Change:			
To accurately reflect device characteristics.			
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):			
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.			
Changes to product identification resulting from this notification:			
None.			
Product Affected:			
LM317DCY	LM317DCYG3	LM317DCYR	LM317DCYRG3
LM317KCS	LM317KCSE3	LM317KCT	LM317KTTR
LM317KTTRG3			

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN_ww_admin_team@list.ti.com

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